IR3P60B Y/C Switch IC

(Model No.: IR3P60B)

Spec No.: EL082048

Issue Date: February 15, 1996



SPEC No.	ELO	8 2	0 4 8
ISSUE:	Feb.	15	1996

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Y/C SWITCH IC
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PRESENTED
BY: T. Ohna T. OHNO

Tenri Division

Tenri Integrated Circuits Group

SHARP CORPORATION

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 - Home appliances
 - •Communication equipment other than for trunk lines
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 - Mainframe computers
 - •Traffic control systems
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1. Description

The IR3P60B is a signal switching IC for the TV Y/C separation input (S terminal) that switches 3-line external S input and the internal signal to the luminance signal (Y) and the chrominance signal(C) simultaneously.

Synchronizing signal switching circuit is built-in.

As well as CA and CB switching the input, S1, S2, and S3

selects the external S input and the internal signal.

2. Features

- i) Good frequency characteristics
- ii) Reduced crosstalk
- iii) Built-in 6dB amplifier
 - iv) Built-in synchronizing signal switching circuit
 - v) Chrominance signal delay line connector terminal provided

Not designed or rated as radiation hardened.

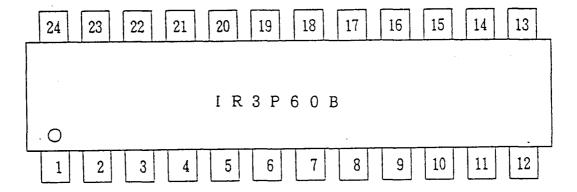
Package material: Plastic

Chip material: P-type silicon substrate

Number of pins: 24-pin shrink dual-in-line package

Process: Bipolar

3. Terminal Connections



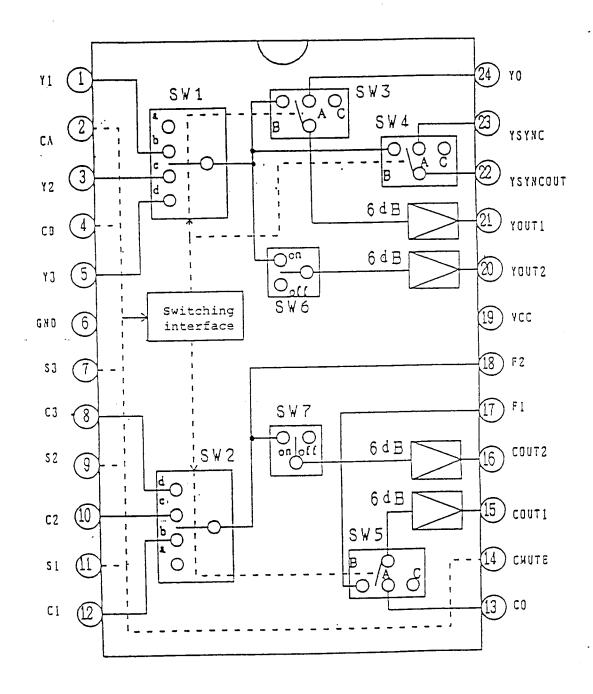
Package 24-pin shrink DIP (TOP VIEW)

4. Terminal Name

No.	Symbol	Name-
1	Yl	External luminance signal input l
2	CA	Input select pin A
3	Y2	External luminance signal input 2
4	СВ	Input select pin B
5	Y3	External luminance signal input 3
6	GND	GND pin
7	S 3	Input select pin 3
8	C3	External chrominance signal input 3
9	S2	Input select pin 2
10	C2	External chrominance signal input 2

No.	Symbol	Name
11	Sl	Input select pin l
12	C1	External chrominance signal input l
13	С0	Internal chrominance signal input
14	CMUTE	Mute pin
15	COUTL	Chrominance signal output l
16	COUT2	Chrominance signal output 2
17	Fl	Delay line 1
18	F2	Delay line 2
19	VCC	Power supply pin
20	YOUT2	Luminance signal output 2
21	YOUTl	Luminance signal output l
22	YSYNCOUT	Synchronizing signal output
23	YSYNC	Synchronizing signal input
24	YO	Internal luminance signal input

5. Block Diagram

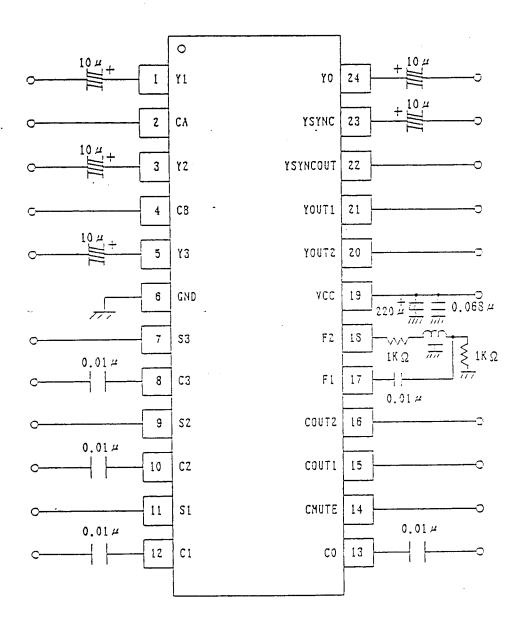


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6. Basic Connection Diagram



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7. Description of Functional Operation

i) Terminal function

Pin	1/0	Description
1	I	External luminance signal input pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11.
2	· I	Input select pin. Selects an input in conjunction with Pins 4, 7, 9, and 11.
3	I	External luminance signal input pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11.
4	I	Input select pin. Selects an input in conjunction with Pins 2, 7, 9, and 11.
5	I	External luminance signal input pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11.
6	I	Ground pin
7	I	Input select pin. Selects the external signal input 3 or the internal signal input.
8	I	External chrominance signal input pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11.
9	I	Input select pin. Selects the external signal input 2 or the internal signal input.
10	I	External chrominance signal input pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11.
11	I	Input select pin. Selects the external signal input l and the internal signal input.
12	I	External chrominance signal input pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11.

IR3P60B

Pin	1/0	Description
13	I	Internal chrominance signal input pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11.
14	I	Mute pin. Turning this pin "High" mutes the outputs from Pins 15, 21, and 22. (YOUTL, YSYNCOUT, COUTL)
15	0	Chrominance signal output pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11. Muted by Pin 14 going "High".
16	0	Chrominance signal output pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11.
17	I	Input pin from the delay line
18	0	Output pin to the delay line. If the delay line is out of use, connect Pins 17 and 18 via a capacitor.
19		Power supply pin
20	0	Luminance signal output pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11.
21	0	Luminance signal output pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11. Muted by Pin 14 going "High".
22	0	Synchronizing and external signal output pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11. Muted by Pin 14 going "High".
23	I	Synchronizing signal input pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11.
24	I	Internal luminance signal input pin. The input signal is selected according to the voltages applied to Pins 2, 4, 7, 9, and 11.



ii) Description of functional operation
Control mode table

When CMUTE is "Low"

СВ	CA	s 3	S .2	s1	YOUTL	YOUT2	YSYNCOUT	COUT1	COUT2
L	L	*	*	*	YO	-	YSYNC	C0	-
L.	H	*	*	L	YO	_	YSYNC	C0	-
L	Н	*	*	H	Yl	-	Yl	Cl	-
Н	L	*	L	*	YO	¥2	YSYNC	CO	C2
H	L	*	H	*	Y 2	¥2	Y2	C2	C2
H	Н	L	*	*	YO	Y3	YSYNC	C0	C3
H	Н	Н	*	*	¥3	Y3	¥3	C3	C3

Note) Pins S3, S2, S1 OPEN="High"

When CMUTE is "High", each output of YOUT1, YSYNCOUT, and COUT1 will be muted, meaning no signal output will be made. But YOUT2, and COUT2 will not be muted, so that signal outputs will be made on these pins.

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Control mode table for each switch

(Each alphabet letter corresponds to one switch location shown in the block diagram.)

When CMUTE is "Low"

СВ	CA	S 3	S2	Sl	SWL	SW2	SW3	SW4	SW5	SW6,SW7
L	L	*	*	*	a	a	A	A	A	ON
L	Н	*	*	L	b	ъ	A	A	A	OFF
L	Н	*	*	Н	b	ъ	В	В	В	OFF
Н	L	*	L	*	С	С	A	A	Α -	ON
H	L	*	Н	*	С	С	В	В	В	ОИ
H	Н	L	*	*	đ	đ	A	A	A	ОИ
H	Н	Н	*	*	đ	đ	В	В	В	ОИ

When CMUTE is "High"

SW3	SW4	SW5
С	С	С

Note that the modes of the switches SW1, SW2, SW6, and SW7 are determined by the states of CA, CB, S1, S2, and S3.

8. Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit	Remark
Supply voltage	Vcc	15.0	V	
Input signal voltage	Vin	5.0	Vp-p	
Control voltage	VIN	0 ∿ VCC	٧	
Power dissipation	Pd	1500	mW	Ta ≤ 25°C
derating ratio		12	mW/°C	Ta > 25°C
Operating temperature	Topr	-20 ∿ +75	°C	
Storage temperature	Tstg	-55 ∿ +150	°C	

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9. Electrical Characteristics

(Unless otherwise specified, Ta=-20°C \sim +75°C, Vcc=8.0V \sim 12.0V)

Parameter	Symbol	Condition	Ra	Unit		
	-		MIN. TYP. MAX.			
Operating voltage range	Icc		8	9	12	V
Current dissipation	Icc	Vcc=9V	30	42	65	mA
Switching threshold I (CA, CB, CMUTE)	Vthc		1.5	1.9	2.5	V
Select pin impedance I (CA, CB, CMUTE)	Rc		22	35		kΩ
Switching	Vths	Vcc=9.0V	1.0	2.0	2.5	v
threshold II (S1, S2, S3)		Vcc=9.0V - 12.0V	0.8	2.0	3.7	٧
Select pin impedance II (S1, S2, S3)	Rs		33	55		kΩ
Gain (1) (YOUT1,2, COUT1,2)	Gl		5	6	7	đВ
Gain (2) (YSYNCOUT)	G2		-1	0	1	đВ
Frequency characteristics	f	Sine wave lVp-p Vopp/Vipp Point which is -3dB away from l00kHz	20	40		MHz
Output YOUT, COUT		Rectangular wave	0.06	0.1		V/nsec
through- YSNCOUT	SR	5MHz, lVp-p	0.03	0.06		V/nsec



Paramete	<u> </u>	Symbol	Condition Rating				Unit
		0,			TYP.	MAX.	
Mute characteristics YOUT1, YSYNCOUT COUT1		MUTE	1 - 5MHz	50	55		đВ
Crosstal Y - C	.k (1)	CYC	1 - 5MHz	55	60		đВ
Crosstal Mode - m		Cmod	1 - 5MHz	55	60		đВ
	Y input	Zin	Sine wave 100kHz	10	15	20	kΩ
impedano	C input	2111	Sine wave 100kHz	10	15	20	kΩ
			Sine wave 3.58MHz		8		kΩ
	YOUT, COUT		Sine wave 100kHz		20	40	
imped- ance	YSYNCOUT	Zou	Sine wave 100kHz		35	60	
	/F2		Sine wave 100kHz		45	90	
	Le Y0 - Y3	Vin	Vcc=9.0V APL10-90% 1.4 1.8			Vp-p	
input		VIN	Vcc=9.0V Sine wave 100kHz	1.8	2.3		Vp-p
	C0 - C3		Vcc=9.0V Sine wave 3.58MHz	1.8	2.3		Vp-p
Differentiation gain		DG	Input lVp-p			3	8
Differer phase	ntiation	DP	Input lVp-p			3	deg

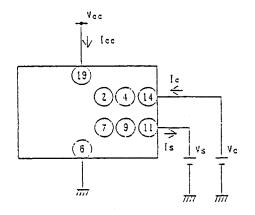
Reference input signal

Y signal: lVp-p, Sync negative (SYNC: 0.286Vp-p)

C signal: Burst 0.286Vp-p

1Vp-p Composite signal or Y component signal Sync negative (SYNC: 0.286Vp-p) YSYNC:

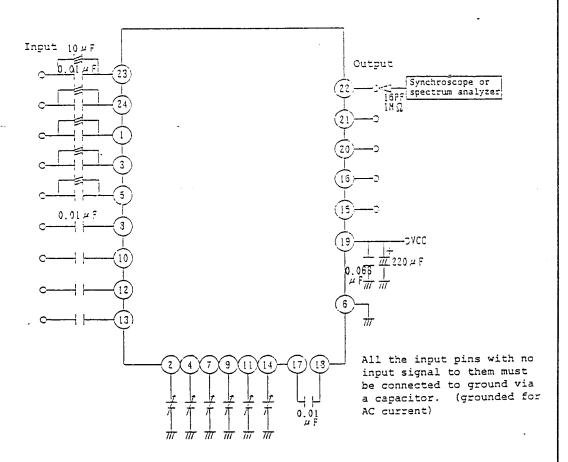
O Test circuit for current dissipation, switching pin impedance



Current dissipation Icc Switching pin impedance

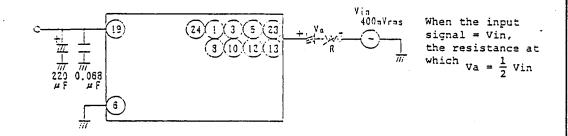
$$R_{c} = \frac{\gamma_{c}}{l_{c}}$$

O Test circuit for AC characteristics

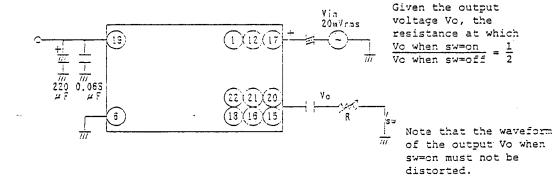


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O Test circuit for input impedance

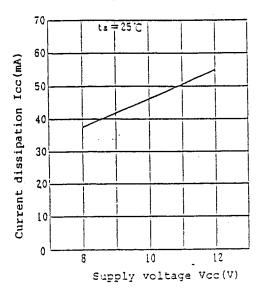


O Test circuit for output impedance

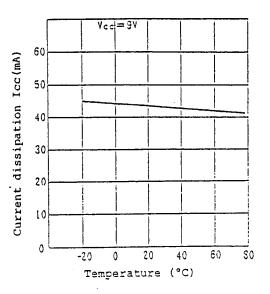


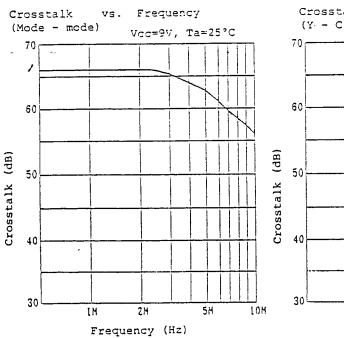
Typical Characteristic Examples

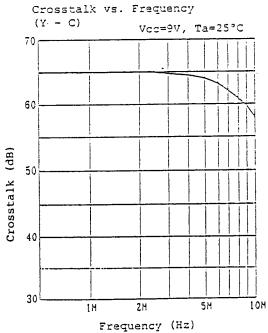
Current dissipation vs. Supply voltage Current dissipation vs. Temperature

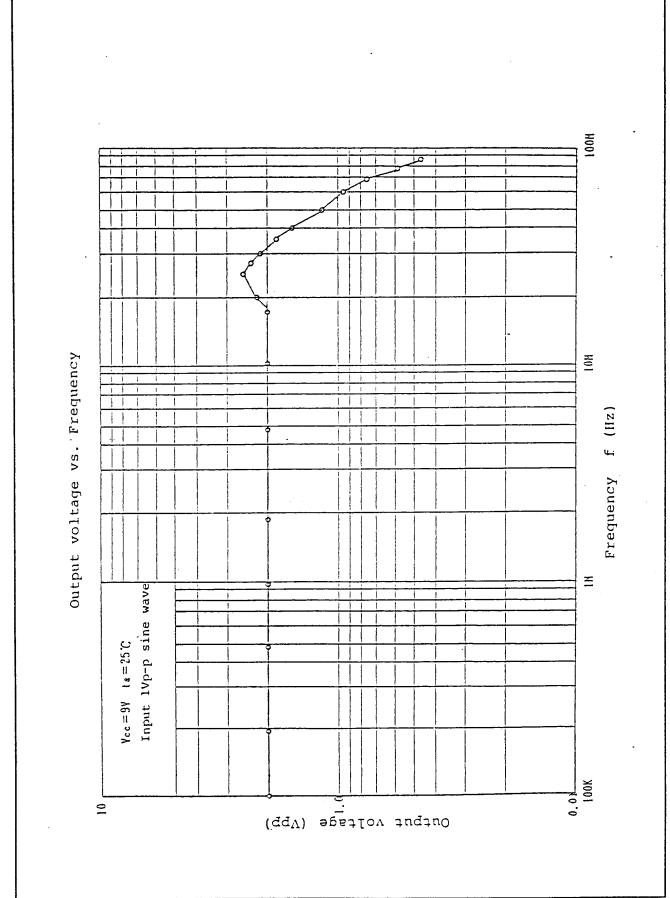


10.

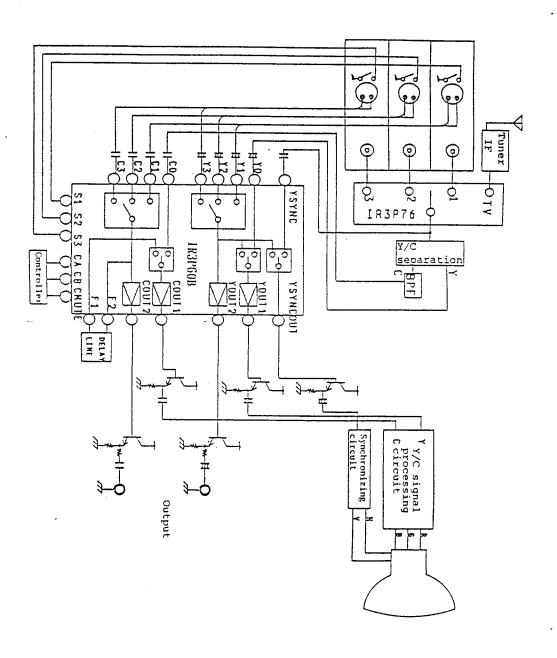








11. Application Circuit Example

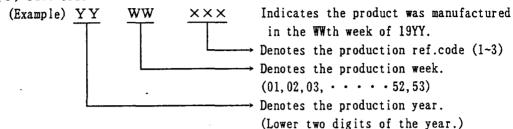


12 Package and packing specification

1. Package Outline Specification
Refer to drawing No. AA 8 5 7

2. Markings

- 2-1. Marking contents
 - (1) Product name : IR3P60B
 (2) Company name : SHARP
 - (3) Date code



(4) The marking of "JAPAN" indicates the country of origin.

2-2. Marking layout

Refer to drawing No. AA857

(This layout do not define the dimensions of marking character and marking position.)

3. Packing Specification

3-1. Packing materials

Material Name	Material Specification.	Purpose			
Magazine	Anti-static treated plastic (22devices/magazine)	Packing of device			
Stopper	Plastic or rubber	Fixing of device			
Label Paper		Indication of product name, quantity and date of manufacture.			
Inner case	Cardboard (880devices/cace)	Fixing of magazine			
Outer case	Cardboard	Outer packing of magazine			

(Devices shall be inserted into a magazine (sleeve) in the same direction.)

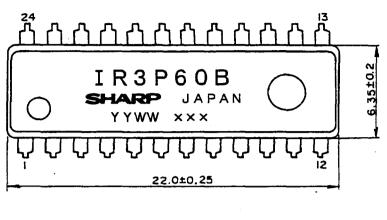
3-2. Outline dimension of magazine (sleeve)

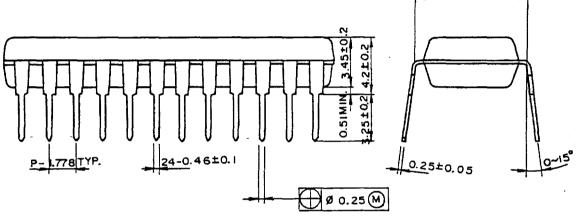
Refer to attached drawing.

4. Precausion For Unpacking

- (1) Unpacking should be done on the stand as well as human body treated with anti-ESD.
- (2) Anti-ESD treatment is given to a magazine.

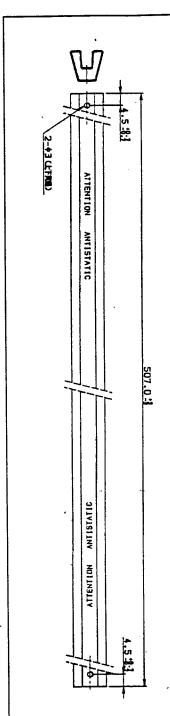
 Use the equivalent magazine, if it is changed to another one.
- (3) Be sure to fix two stoppers to both ends of a magazine when storage to prevent the devices from slipping.

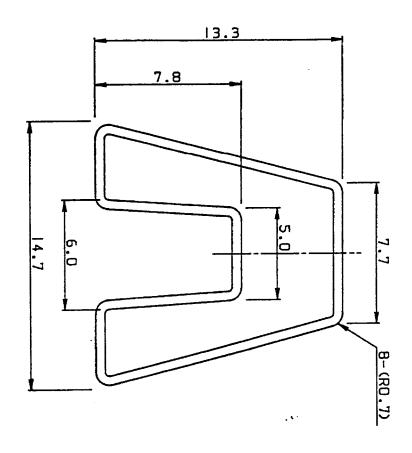




7. 62TYP,

名科	5		リード仕上	TIN-LEAD	備考	プラスチックパッケージ外形寸法は、バリを含まないものとする。
NAM	SDIP24-F	-300	LEAD FINISH	PLATING	NOTE	Plastic body dimensions do not include burr
			単位			of resin.
DR.	AWING NO.	AA85	7 UNIT	mm		





注記 :片側ピンストッパー,片側ゴムストッパーとする。

指示無き寸法公差は全て±0.4とする。

NOTES: One end of magazine (sleeve) is plugged by stopper which is

made of rubber, and another end of magazine (sleeve) is

plugged by plastic pin-stopper.

All tolerances are ±0.4mm unless otherwise specified

名称				備考
NAME	DP300	SPB		NOTE
		単位		
DRAWING NO.	CV503	UNIT	mm	